



APPLICATION DATA SHEET

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Title of Invention	[METHOD OF FABRICATING SHALLOW TRENCH ISOLATION STRUCTURE FOR REDUCING WAFER SCRATCH]		
Application Type : regular, utility Attorney Docket Number : 13155-US-PA			
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Attorney Information: practitioner(s) at Customer Number: 31561  as my attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.			